

Filename: Pro4DA7.tmp  
 Variant: 001  
 Generated: 6/4/2018 11:29:29 AM  
 TID #: TIDA-01566



### TIDA-01566 REV E1 Bill of Materials

Item #	Designator	Quantity	Value	PartNumber	Manufacturer	Description	PackageReference
1	PCB	1		TIDA-01566	Any	Printed Circuit Board	
2	C1, C2, C3	3	4.7uF	GRM035R60J475ME15D	MuRata	CAP, CERM, 4.7 $\mu$ F, 6.3 V, +/- 20%, X5R, 0201	0201
3	C10	1	47uF	GRM21BR60J476ME15L	MuRata	CAP, CERM, 47 $\mu$ F, 6.3 V, +/- 20%, X5R, 0805	0805
4	J1, J2, J3	3		TSW-106-07-G-S	Samtec	Header, 100mil, 6x1, Gold, TH	6x1 Header
5	J4	1		TSW-102-07-G-S	Samtec	Header, 100mil, 2x1, Gold, TH	2x1 Header
6	J5, J6, J7, J8	4		142-0701-231	Cinch Connectivity	Connector, SMA, TH	SMA
7	JP1, JP2, JP3	3		TSW-103-07-G-S	Samtec	Header, 100mil, 3x1, Gold, TH	3x1 Header
8	JP4	1		JMP-36-30X40SMT	Any	Jumper, SMT	shorting jumper, SMT
9	L1	1	470nH	HTE1005FE-R47MSR-11	Cyntec	Inductor, 470 nH, 0.9 A, 0.175 ohm, SMD	1x0.5mm
10	R1	1	133k	RC0201FR-07133KL	Yageo America	RES, 133 k, 1%, 0.05 W, 0201	0201
11	R10, R11, R12, R15	4	49.9	RC0402FR-0749R9L	Yageo America	RES, 49.9, 1%, 0.063 W, 0402	0402
12	TP1, TP2, TP3	3		5000	Keystone	Test Point, Miniature, Red, TH	Red Miniature Testpoint
13	TP4	1		5002	Keystone	Test Point, Miniature, White, TH	White Miniature Testpoint
14	TP5	1		5001	Keystone	Test Point, Miniature, Black, TH	Black Miniature Testpoint
15	U1	1		TPS62801YKAR	Texas Instruments	Tiny High Frequency Ultra-low Iq Step-Down Converter, YKA0006ACAC (DSBGA-6)	YKA0006ACAC
16	U2	1		TPS7A1012PYKAR	Texas Instruments	300mA Low VIN, Low VOUT, Ultra-Low Dropout Regulator, YKA0005AFAP (DSBGA-5)	YKA0005AFAP
17	C11	0	10uF	GRM155R60J106ME15D	MuRata	CAP, CERM, 10 $\mu$ F, 6.3 V, +/- 20%, X5R, 0402	0402
18	C12, C13	0	4.7uF	GRM035R60J475ME15D	MuRata	CAP, CERM, 4.7 $\mu$ F, 6.3 V, +/- 20%, X5R, 0201	0201
19	FID1, FID2, FID3	0		N/A	N/A	Fiducial mark. There is nothing to buy or mount.	Fiducial
20	R13	0	133k	CRCW0603133KFKEA	Vishay-Dale	RES, 133 k, 1%, 0.1 W, 0603	0603
21	R14	0	1.0Meg	CRCW06031M00JNEA	Vishay-Dale	RES, 1.0 M, 5%, 0.1 W, AEC-Q200 Grade 0, 0603	0603

## IMPORTANT NOTICE FOR TI DESIGN INFORMATION AND RESOURCES

Texas Instruments Incorporated ("TI") technical, application or other design advice, services or information, including, but not limited to, reference designs and materials relating to evaluation modules, (collectively, "TI Resources") are intended to assist designers who are developing applications that incorporate TI products; by downloading, accessing or using any particular TI Resource in any way, you (individually or, if you are acting on behalf of a company, your company) agree to use it solely for this purpose and subject to the terms of this Notice.

TI's provision of TI Resources does not expand or otherwise alter TI's applicable published warranties or warranty disclaimers for TI products, and no additional obligations or liabilities arise from TI providing such TI Resources. TI reserves the right to make corrections, enhancements, improvements and other changes to its TI Resources.

You understand and agree that you remain responsible for using your independent analysis, evaluation and judgment in designing your applications and that you have full and exclusive responsibility to assure the safety of your applications and compliance of your applications (and of all TI products used in or for your applications) with all applicable regulations, laws and other applicable requirements. You represent that, with respect to your applications, you have all the necessary expertise to create and implement safeguards that (1) anticipate dangerous consequences of failures, (2) monitor failures and their consequences, and (3) lessen the likelihood of failures that might cause harm and take appropriate actions. You agree that prior to using or distributing any applications that include TI products, you will thoroughly test such applications and the functionality of such TI products as used in such applications. TI has not conducted any testing other than that specifically described in the published documentation for a particular TI Resource.

You are authorized to use, copy and modify any individual TI Resource only in connection with the development of applications that include the TI product(s) identified in such TI Resource. NO OTHER LICENSE, EXPRESS OR IMPLIED, BY ESTOPPEL OR OTHERWISE TO ANY OTHER TI INTELLECTUAL PROPERTY RIGHT, AND NO LICENSE TO ANY TECHNOLOGY OR INTELLECTUAL PROPERTY RIGHT OF TI OR ANY THIRD PARTY IS GRANTED HEREIN, including but not limited to any patent right, copyright, mask work right, or other intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information regarding or referencing third-party products or services does not constitute a license to use such products or services, or a warranty or endorsement thereof. Use of TI Resources may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

TI RESOURCES ARE PROVIDED "AS IS" AND WITH ALL FAULTS. TI DISCLAIMS ALL OTHER WARRANTIES OR REPRESENTATIONS, EXPRESS OR IMPLIED, REGARDING TI RESOURCES OR USE THEREOF, INCLUDING BUT NOT LIMITED TO ACCURACY OR COMPLETENESS, TITLE, ANY EPIDEMIC FAILURE WARRANTY AND ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE, AND NON-INFRINGEMENT OF ANY THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

TI SHALL NOT BE LIABLE FOR AND SHALL NOT DEFEND OR INDEMNIFY YOU AGAINST ANY CLAIM, INCLUDING BUT NOT LIMITED TO ANY INFRINGEMENT CLAIM THAT RELATES TO OR IS BASED ON ANY COMBINATION OF PRODUCTS EVEN IF DESCRIBED IN TI RESOURCES OR OTHERWISE. IN NO EVENT SHALL TI BE LIABLE FOR ANY ACTUAL, DIRECT, SPECIAL, COLLATERAL, INDIRECT, PUNITIVE, INCIDENTAL, CONSEQUENTIAL OR EXEMPLARY DAMAGES IN CONNECTION WITH OR ARISING OUT OF TI RESOURCES OR USE THEREOF, AND REGARDLESS OF WHETHER TI HAS BEEN ADVISED OF THE POSSIBILITY OF SUCH DAMAGES.

You agree to fully indemnify TI and its representatives against any damages, costs, losses, and/or liabilities arising out of your non-compliance with the terms and provisions of this Notice.

This Notice applies to TI Resources. Additional terms apply to the use and purchase of certain types of materials, TI products and services. These include; without limitation, TI's standard terms for semiconductor products (<http://www.ti.com/sc/docs/stdterms.htm>), [evaluation modules](#), and [samples](http://www.ti.com/sc/docs/sampterm.htm) (<http://www.ti.com/sc/docs/sampterm.htm>).

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265  
Copyright © 2018, Texas Instruments Incorporated